PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Docket No: Q88153

Koji WATANABE, et al.

Appln. No.: 10/541,586 Group Art Unit: 1796

Confirmation No.: 1996 Examiner: Michael J FEELY

Filed: July 7, 2005

For: CURING RESIN COMPOSITION, ADHESIVE EPOXY RESIN PASTE, ADHESIVE EPOXY RESIN SHEET, CONDUCTIVE CONNECTION PASTE, CONDUCTIVE CONNECTION SHEET. AND ELECTRONIC COMPONENT JOINED BODY

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §§ 1.97 and 1.98

MAIL STOP AMENDMENT

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the documents which are listed on the attached PTO/SB/08a form and/or listed herein and which the Examiner may deem material to patentability of the claims of the above-identified application.

One copy of each of the listed documents is submitted herewith, except for the following: U.S. patents and/or U.S. patent publications; and co-pending non-provisional U.S. applications filed after June 30, 2003.

The present Information Disclosure Statement is being filed before the mailing date of the first Office Action on the merits, and therefore no Statement under 37 C.F.R. § 1,97(e) or fee under 37 C.F.R. § 1.17(p) is required. However, since the conditions therefore apply, Applicant submits herewith a Statement Under 37 C.F.R. § 1.97(e).

Attorney Docket No.: Q88153

Applicants enclose herewith a copy of an Office Action communication from the Japanese Patent Office in counterpart Japanese Application No. 2003-403703 citing the listed document.

Further in compliance with the concise explanation requirement under 37 C.F.R. § 1.98(a)(3) for foreign language documents, Applicant submits the following:

 An English language abstract of JP 03-205445 submitted herewith constitutes a concise statement of relevance of JP 03-205445.

It is noted that JP 2002-241584, also cited in the Japanese Office Action in the counterpart Japanese patent application, was previously cited in the Information Disclosure Statement of July 7, 2005, and thus is not being listed on the Form PTO/SB/08a submitted herewith

The submission of the listed documents is not intended as an admission that any such document constitutes prior art against the claims of the present application. Applicant does not waive any right to take any action that would be appropriate to antedate or otherwise remove any listed document as a competent reference against the claims of the present application.

INFORMATION DISCLOSURE STATEMENT

UNDER 37 C.F.R. §§ 1.97 and 1.98 U.S. Appln. No.: 10/541,586

The USPTO is directed and authorized to charge the statutory fee of and all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account.

Respectfully submitted,

Attorney Docket No.: Q88153

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WASHINGTON OFFICE 23373
CUSTOMER NUMBER

Date: August 12, 2008

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STATEMENT UNDER 37 C.F.R. § 1.97(e)

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The undersigned hereby states, upon information and belief:

That each item of information contained in the Information Disclosure Statement filed concurrently herewith was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of said Information Disclosure Statement.

Respectfully submitted,

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washington office 23373 customer number

Date: August 12, 2008